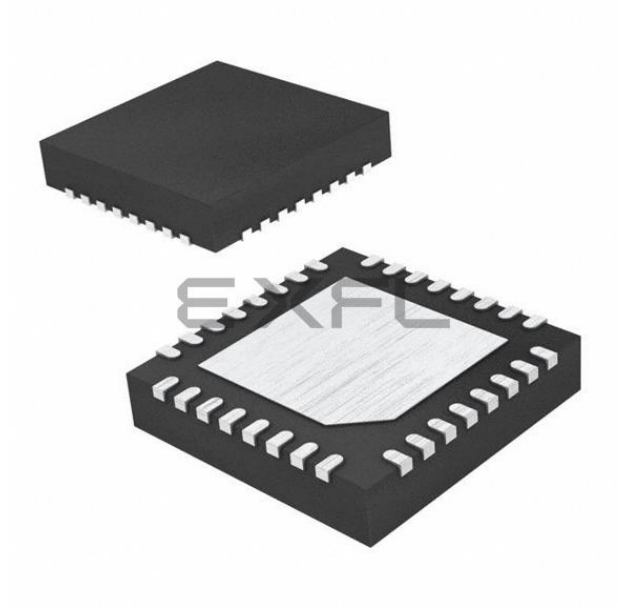

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Details	
Product Status	Active
Core Processor	PIC
Core Size	16-Bit
Speed	32MHz
Connectivity	I²C, IrDA, LINbus, SmartCard, SPI, UART/USART
Peripherals	AES, Brown-out Detect/Reset, DMA, I²S, HLVD, POR, PWM, WDT
Number of I/O	20
Program Memory Size	64KB (64K x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	8K x 8
Voltage - Supply (Vcc/Vdd)	2V ~ 3.6V
Data Converters	A/D 9x10b/12b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 125°C (TA)
Mounting Type	Surface Mount
Package / Case	28-VQFN Exposed Pad
Supplier Device Package	28-QFN-S (6x6)
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/pic24fj64gb202-e-mm

TABLE 1-3: PIC24FJ128GB204 FAMILY PINOUT DESCRIPTION (CONTINUED)

Pin Function	Pin Number/Grid Locator			I/O	Input Buffer	Description
	28-Pin SPDIP/SOIC/ SSOP	28-Pin QFN-S	44-Pin TQFP/QFN			
PMA0/PMALL	—	—	3	O	—	Parallel Master Port Address.
PMA1/PMALH	—	—	2	O	—	
PMA14/PMCS/ PMCS1	—	—	15	O	—	
PMA2/PMALU	—	—	12	O	—	
PMA3	—	—	38	O	—	
PMA4	—	—	37	O	—	
PMA5	—	—	4	O	—	
PMA6	—	—	5	O	—	
PMA7	—	—	13	O	—	
PMA8	—	—	32	O	—	
PMA9	—	—	35	O	—	
PMACK1	—	—	27	I	ST/TTL	Parallel Master Port Acknowledge Input 1.
PMBE0	—	—	36	O	—	Parallel Master Port Byte Enable 0 Strobe.
PMBE1	—	—	25	O	—	Parallel Master Port Byte Enable 1 Strobe.
PMCS1	—	—	30	I/O	ST/TTL	Parallel Master Port Chip Select 1 Strobe.
PMD0	—	—	21	I/O	ST/TTL	Parallel Master Port Data (Demultiplexed Master mode) or Address/Data (Multiplexed Master modes).
PMD1	—	—	22	I/O	ST/TTL	
PMD2	—	—	23	I/O	ST/TTL	
PMD3	—	—	1	I/O	ST/TTL	
PMD4	—	—	44	I/O	ST/TTL	
PMD5	—	—	43	I/O	ST/TTL	
PMD6	—	—	20	I/O	ST/TTL	
PMD7	—	—	19	I/O	ST/TTL	
PMRD	—	—	11	O	—	Parallel Master Port Read Strobe.
PMWR	—	—	24	O	—	Parallel Master Port Write Strobe.
RA0	2	27	19	I/O	ST	PORTA Digital I/Os.
RA1	3	28	20	I/O	ST	
RA2	9	6	30	I/O	ST	
RA3	10	7	31	I/O	ST	
RA4	12	9	34	I	ST	
RA7	—	—	13	I/O	ST	
RA8	—	—	32	I/O	ST	
RA9	—	—	35	I/O	ST	
RA10	—	—	12	I/O	ST	

Legend: ST = Schmitt Trigger input; TTL = TTL compatible input; I = Input
ANA = Analog input; O = Output; P = Power
I^2C = ST with I^2C™ or SMBus levels

2.6 External Oscillator Pins

Many microcontrollers have options for at least two oscillators: a high-frequency Primary Oscillator and a low-frequency Secondary Oscillator (refer to **Section 9.0 "Oscillator Configuration"** for details).

The oscillator circuit should be placed on the same side of the board as the device. Place the oscillator circuit close to the respective oscillator pins with no more than 0.5 inch (12 mm) between the circuit components and the pins. The load capacitors should be placed next to the oscillator itself, on the same side of the board.

Use a grounded copper pour around the oscillator circuit to isolate it from surrounding circuits. The grounded copper pour should be routed directly to the MCU ground. Do not run any signal traces or power traces inside the ground pour. Also, if using a two-sided board, avoid any traces on the other side of the board where the crystal is placed.

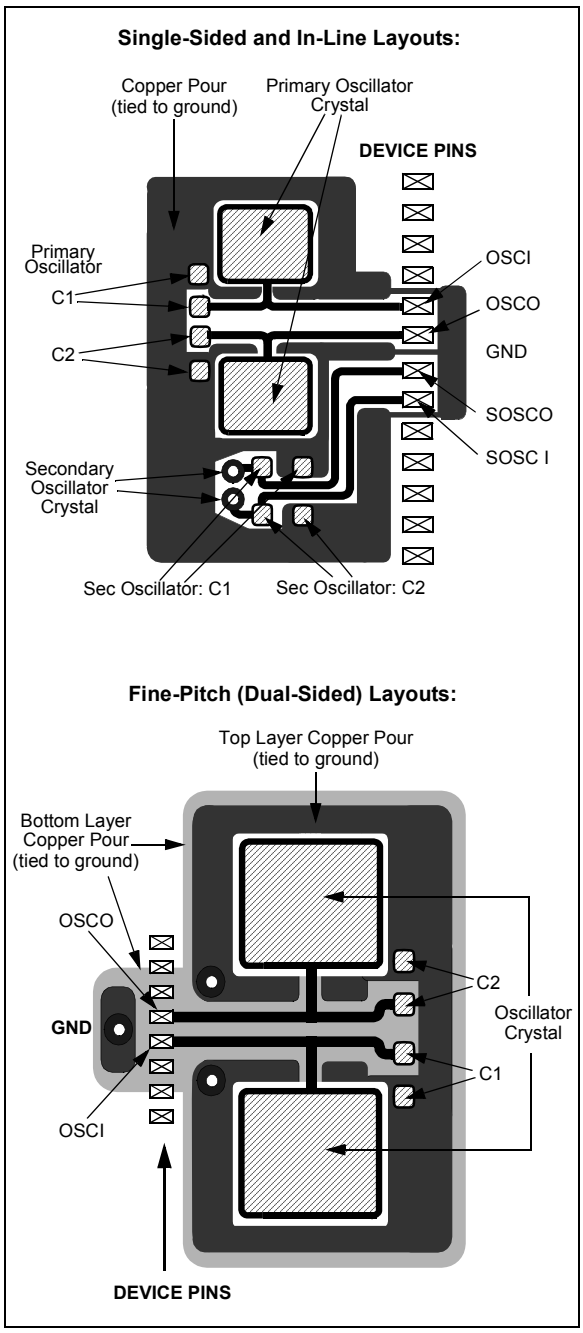
Layout suggestions are shown in Figure 2-5. In-line packages may be handled with a single-sided layout that completely encompasses the oscillator pins. With fine-pitch packages, it is not always possible to completely surround the pins and components. A suitable solution is to tie the broken guard sections to a mirrored ground layer. In all cases, the guard trace(s) must be returned to ground.

In planning the application's routing and I/O assignments, ensure that adjacent port pins, and other signals in close proximity to the oscillator, are benign (i.e., free of high frequencies, short rise and fall times and other similar noise).

For additional information and design guidance on oscillator circuits, please refer to these Microchip Application Notes, available at the corporate web site (www.microchip.com):

- *AN826, "Crystal Oscillator Basics and Crystal Selection for rfPIC™ and PICmicro® Devices"*
- *AN849, "Basic PICmicro® Oscillator Design"*
- *AN943, "Practical PICmicro® Oscillator Analysis and Design"*
- *AN949, "Making Your Oscillator Work"*

FIGURE 2-5: SUGGESTED PLACEMENT OF THE OSCILLATOR CIRCUIT



REGISTER 3-2: CORCON: CPU CORE CONTROL REGISTER

U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
—	—	—	—	—	—	—	—
bit 15							bit 8

U-0	U-0	U-0	U-0	R/C-0	r-1	U-0	U-0
—	—	—	—	IPL3(1)	—	—	—
bit 7							bit 0

Legend:	C = Clearable bit	r = Reserved bit	
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 15-4 **Unimplemented:** Read as '0'

bit 3 **IPL3:** CPU Interrupt Priority Level Status bit(1)
1 = CPU Interrupt Priority Level is greater than 7
0 = CPU Interrupt Priority Level is 7 or less

bit 2 **Reserved:** Read as '1'

bit 1-0 **Unimplemented:** Read as '0'

Note 1: The IPL3 bit is concatenated with the IPL<2:0> bits (SR<7:5>) to form the CPU Interrupt Priority Level; see Register 3-1 for bit description.

TABLE 4-28: PERIPHERAL PIN SELECT REGISTER MAP (CONTINUED)

File Name	Addr	Bit 15	Bit 14	Bit 13	Bit 12	Bit 11	Bit 10	Bit 9	Bit 8	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	All Resets
RPOR0	03D6	—	—	RP1R5	RP1R4	RP1R3	RP1R2	RP1R1	RP1R0	—	—	RP0R5	RP0R4	RP0R3	RP0R2	RP0R1	RP0R0	0000
RPOR1	03D8	—	—	RP3R5	RP3R4	RP3R3	RP3R2	RP3R1	RP3R0	—	—	RP2R5	RP2R4	RP2R3	RP2R2	RP2R1	RP2R0	0000
RPOR2	03DA	—	—	RP5R<5:0>						—	—	—	—	—	—	—	—	0000
RPOR3	03DC	—	—	RP7R5	RP7R4	RP7R3	RP7R2	RP7R1	RP7R0	—	—	RP6R5	RP6R4	RP6R3	RP6R2	RP6R1	RP6R0	0000
RPOR4	03DE	—	—	RP9R5	RP9R4	RP9R3	RP9R2	RP9R1	RP9R0	—	—	RP8R5	RP8R4	RP8R3	RP8R2	RP8R1	RP8R0	0000
RPOR5	03E0	—	—	RP11R5	RP11R4	RP11R3	RP11R2	RP11R1	RP11R0	—	—	RP10R5	RP10R4	RP10R3	RP10R2	RP10R1	RP10R0	0000
RPOR6	03E2	—	—	RP13R<5:0>						—	—	—	—	—	—	—	—	0000
RPOR7	03E4	—	—	RP15R5	RP15R4	RP15R3	RP15R2	RP15R1	RP15R0	—	—	RP14R5	RP14R4	RP14R3	RP14R2	RP14R1	RP14R0	0000
RPOR8	03E6	—	—	RP17R5	RP17R4	RP17R3	RP17R2	RP17R1	RP17R0	—	—	RP16R5	RP16R4	RP16R3	RP16R2	RP16R1	RP16R0	0000
RPOR9	03E8	—	—	RP19R5	RP19R4	RP19R3	RP19R2	RP19R1	RP19R0	—	—	RP18R5	RP18R4	RP18R3	RP18R2	RP18R1	RP18R0	0000
RPOR10	03EA	—	—	RP21R5	RP21R4	RP21R3	RP21R2	RP21R1	RP21R0	—	—	RP20R5	RP20R4	RP20R3	RP20R2	RP20R1	RP20R0	0000
RPOR11	03EC	—	—	RP23R5	RP23R4	RP23R3	RP23R2	RP23R1	RP23R0	—	—	RP22R5	RP22R4	RP22R3	RP22R2	RP22R1	RP22R0	0000
RPOR12	03EE	—	—	RP25R5	RP25R4	RP25R3	RP25R2	RP25R1	RP25R0	—	—	RP24R5	RP24R4	RP24R3	RP24R2	RP24R1	RP24R0	0000

Legend: — = unimplemented, read as '0'. Reset values are shown in hexadecimal.

TABLE 4-29: SYSTEM CONTROL (CLOCK AND RESET) REGISTER MAP

File Name	Addr	Bit 15	Bit 14	Bit 13	Bit 12	Bit 11	Bit 10	Bit 9	Bit 8	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	All Resets
RCON	0108	TRAPR	IOPUWR	—	RETEN	—	DPSLP	CM	VREGS	EXTR	SWR	SWDTEN	WDTO	SLEEP	IDLE	BOR	POR	Note 1
OSCCON	0100	—	COSC2	COSC1	COSC0	—	NOSC2	NOSC1	NOSC0	CLKLOCK	IOLOCK	LOCK	—	CF	POSCEN	SOSCEN	OSWEN	Note 2
CLKDIV	0102	ROI	DOZE2	DOZE1	DOZE0	DOZEN	RCDIV2	RCDIV1	RCDIV0	CPDIV1	CPDIV0	PLLEN	—	—	—	—	—	0100
OSCTUN	0106	STEN	—	STSIDL	STSRC	STLOCK	STLPOL	STOR	STORPOL	—	—	TUN5	TUN4	TUN3	TUN2	TUN1	TUN0	0000
REFOCONL	0168	ROEN	—	ROSIDL	ROOUT	ROSLP	—	ROSWEN	ROACTIVE	—	—	—	—	ROSEL3	ROSEL2	ROSEL1	ROSEL0	0000
REFOCONH	016A	—	RODIV<14:0>															0000
REFOTRIML	016C	ROTRIM<15:7>									—	—	—	—	—	—	—	0000
HLVDCON	010C	HLVDEN	—	LSIDL	—	—	—	—	—	VDIR	BGVST	IRVST	—	HLVDL3	HLVDL2	HLVDL1	HLVDL0	0000
RCON2	010A	—	—	—	—	—	—	—	—	—	—	—	r	VDDBOR	VDDPOR	VBPOR	VBAT	Note 1

Legend: — = unimplemented, read as '0'; r = reserved bit. Reset values are shown in hexadecimal.

Note 1: The Reset value of the RCON register is dependent on the type of Reset event. For more information, refer to **Section 7.0 "Resets"**.

2: The Reset value of the OSCCON register is dependent on both the type of Reset event and the device configuration. For more information, refer to **Section 9.0 "Oscillator Configuration"**.

REGISTER 5-3: DMAINTn: DMA CHANNEL n INTERRUPT REGISTER

R-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
DBUFWF(1)	—	CHSEL5	CHSEL4	CHSEL3	CHSEL2	CHSEL1	CHSEL0
bit 15							bit 8

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	U-0	U-0	R/W-0
HIGHIF(1,2)	LOWIF(1,2)	DONEIF(1)	HALFIF(1)	OVRUNIF(1)	—	—	HALFEN
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 15 **DBUFWF:** DMA Buffered Data Write Flag bit(1)
- 1 = The content of the DMA buffer has not been written to the location specified in DMADSTn or DMASRCn in Null Write mode
- 0 = The content of the DMA buffer has been written to the location specified in DMADSTn or DMASRCn in Null Write mode

bit 14 **Unimplemented:** Read as '0'

bit 13-8 **CHSEL<5:0>:** DMA Channel Trigger Selection bits

See Table 5-1 for a complete list.

bit 7 **HIGHIF:** DMA High Address Limit Interrupt Flag bit(1,2)
- 1 = The DMA channel has attempted to access an address higher than DMAH or the upper limit of the data RAM space
- 0 = The DMA channel has not invoked the high address limit interrupt

bit 6 **LOWIF:** DMA Low Address Limit Interrupt Flag bit(1,2)
- 1 = The DMA channel has attempted to access a DMA SFR address lower than DMAL, but above the SFR range (07FFh)
- 0 = The DMA channel has not invoked the low address limit interrupt

bit 5 **DONEIF:** DMA Complete Operation Interrupt Flag bit(1)

If CHEN = 1:
- 1 = The previous DMA session has ended with completion
- 0 = The current DMA session has not yet completed

If CHEN = 0:
- 1 = The previous DMA session has ended with completion
- 0 = The previous DMA session has ended without completion

bit 4 **HALFIF:** DMA 50% Watermark Level Interrupt Flag bit(1)
- 1 = DMACNTn has reached the halfway point to 0000h
- 0 = DMACNTn has not reached the halfway point

bit 3 **OVRUNIF:** DMA Channel Overrun Flag bit(1)
- 1 = The DMA channel is triggered while it is still completing the operation based on the previous trigger
- 0 = The overrun condition has not occurred

bit 2-1 **Unimplemented:** Read as '0'

bit 0 **HALFEN:** Halfway Completion Watermark bit
- 1 = Interrupts are invoked when DMACNTn has reached its halfway point and at completion
- 0 = An interrupt is invoked only at the completion of the transfer

Note 1: Setting these flags in software does not generate an interrupt.

2: Testing for address limit violations (DMASRCn or DMADSTn is either greater than DMAH or less than DMAL) is NOT done before the actual access.

REGISTER 7-2: RCON2: RESET AND SYSTEM CONTROL REGISTER 2

U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
—	—	—	—	—	—	—	—
bit 15							bit 8

U-0	U-0	U-0	r-0	R/CO-1	R/CO-1	R/CO-1	R/CO-0
—	—	—	—	VDDBOR(1)	VDDPOR(1,2)	VBPOR(1,3)	VBAT(1)
bit 7							bit 0

Legend:	CO = Clearable Only bit	r = Reserved bit	
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 15-5 **Unimplemented:** Read as '0'

bit 4 **Reserved:** Maintain as '0'

bit 3 **VDDBOR:** VDD Brown-out Reset Flag bit(1)
1 = A VDD Brown-out Reset has occurred (set by hardware)
0 = A VDD Brown-out Reset has not occurred

bit 2 **VDDPOR:** VDD Power-on Reset Flag bit(1,2)
1 = A VDD Power-on Reset has occurred (set by hardware)
0 = A VDD Power-on Reset has not occurred

bit 1 **VBPOR:** VBPOR Flag bit(1,3)
1 = A VBAT POR has occurred (no battery is connected to the VBAT pin or VBAT power below the Deep Sleep Semaphore retention level is set by hardware)
0 = A VBAT POR has not occurred

bit 0 **VBAT:** VBAT Flag bit(1)
1 = A POR exit has occurred while power was applied to the VBAT pin (set by hardware)
0 = A POR exit from VBAT has not occurred

Note 1: This bit is set in hardware only; it can only be cleared in software.
2: This bit indicates a VDD Power-on Reset. Setting the POR bit (RCON<0>) indicates a VCORE Power-on Reset.
3: This bit is set when the device is originally powered up, even if power is present on VBAT.

TABLE 7-1: RESET FLAG BIT OPERATION

Flag Bit	Setting Event	Clearing Event
TRAPR (RCON<15>)	Trap Conflict Event	POR
IOPUWR (RCON<14>)	Illegal Opcode or Uninitialized W Register Access	POR
CM (RCON<9>)	Configuration Mismatch Reset	POR
EXTR (RCON<7>)	$\overline{\text{MCLR}}$ Reset	POR
SWR (RCON<6>)	RESET Instruction	POR
WDTO (RCON<4>)	WDT Time-out	CLRWDT, PWRSAV Instructions, POR
SLEEP (RCON<3>)	PWRSAV #0 Instruction	POR
DPSLP (RCON<10>)	PWRSAV #0 Instruction while DSEN bit is Set	POR
IDLE (RCON<2>)	PWRSAV #1 Instruction	POR
BOR (RCON<1>)	POR, BOR	—
POR (RCON<0>)	POR	—

Note: All Reset flag bits may be set or cleared by the user software.

REGISTER 8-23: IPC2: INTERRUPT PRIORITY CONTROL REGISTER 2

U-0	R/W-1	R/W-0	R/W-0	U-0	R/W-1	R/W-0	R/W-0
—	U1RXIP2	U1RXIP1	U1RXIP0	—	SPI1TXIP2	SPI1TXIP1	SPI1TXIP0
bit 15							bit 8

U-0	R/W-1	R/W-0	R/W-0	U-0	R/W-1	R/W-0	R/W-0
—	SPI1IP2	SPI1IP1	SPI1IP0	—	T3IP2	T3IP1	T3IP0
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 15 **Unimplemented:** Read as '0'

bit 14-12 **U1RXIP<2:0>:** UART1 Receiver Interrupt Priority bits
111 = Interrupt is Priority 7 (highest priority interrupt)
•
•
•
001 = Interrupt is Priority 1
000 = Interrupt source is disabled

bit 11 **Unimplemented:** Read as '0'

bit 10-8 **SPI1TXIP<2:0>:** SPI1 Transmit Interrupt Priority bits
111 = Interrupt is Priority 7 (highest priority interrupt)
•
•
•
001 = Interrupt is Priority 1
000 = Interrupt source is disabled

bit 7 **Unimplemented:** Read as '0'

bit 6-4 **SPI1IP<2:0>:** SPI1 General Interrupt Priority bits
111 = Interrupt is Priority 7 (highest priority interrupt)
•
•
•
001 = Interrupt is Priority 1
000 = Interrupt source is disabled

bit 3 **Unimplemented:** Read as '0'

bit 2-0 **T3IP<2:0>:** Timer3 Interrupt Priority bits
111 = Interrupt is Priority 7 (highest priority interrupt)
•
•
•
001 = Interrupt is Priority 1
000 = Interrupt source is disabled

REGISTER 9-3: OSCTUN: FRC OSCILLATOR TUNE REGISTER

R/W-0	U-0	R/W-0	R/W-0	R-0	R/W-0	R-0	R/W-0
STEN	—	STSIDL	STSRC(1)	STLOCK	STLPOL	STOR	STORPOL
bit 15							bit 8

U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
—	—	TUN5	TUN4	TUN3	TUN2	TUN1	TUN0
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 15 **STEN:** FRC Self-Tune Enable bit
1 = FRC self-tuning is enabled; TUNx bits are controlled by hardware
0 = FRC self-tuning is disabled; application may optionally control TUNx bits

bit 14 **Unimplemented:** Read as '0'

bit 13 **STSIDL:** FRC Self-Tune Stop in Idle bit
1 = Self-tuning stops during Idle mode
0 = Self-tuning continues during Idle mode

bit 12 **STSRC:** FRC Self-Tune Reference Clock Source bit(1)
1 = FRC is tuned to approximately match the USB host clock tolerance
0 = FRC is tuned to approximately match the 32.768 kHz SOSC tolerance

bit 11 **STLOCK:** FRC Self-Tune Lock Status bit
1 = FRC accuracy is currently within ±0.2% of the STSRC reference accuracy
0 = FRC accuracy may not be within ±0.2% of the STSRC reference accuracy

bit 10 **STLPOL:** FRC Self-Tune Lock Interrupt Polarity bit
1 = A self-tune lock interrupt is generated when STLOCK = 0
0 = A self-tune lock interrupt is generated when STLOCK = 1

bit 9 **STOR:** FRC Self-Tune Out of Range Status bit
1 = STSRC reference clock error is beyond the range of TUN<5:0>; no tuning is performed
0 = STSRC reference clock is within the tunable range; tuning is performed

bit 8 **STORPOL:** FRC Self-Tune Out of Range Interrupt Polarity bit
1 = A self-tune out of range interrupt is generated when STOR is = 0
0 = A self-tune out of range interrupt is generated when STOR is = 1

bit 7-6 **Unimplemented:** Read as '0'

bit 5-0 **TUN<5:0>:** FRC Oscillator Tuning bits
011111 = Maximum frequency deviation
011110 =
•
•
•
000001 =
000000 = Center frequency, oscillator is running at factory calibrated frequency
111111 =
•
•
•
100001 =
100000 = Minimum frequency deviation

Note 1: Use of either clock recovery source has specific application requirements. For more information, see **Section 9.5 "FRC Self-Tuning"**.

NOTES:

REGISTER 15-2: OCxCON2: OUTPUT COMPARE x CONTROL REGISTER 2

R/W-0	R/W-0	R/W-0	R/W-0	U-0	R/W-0	R/W-0	R/W-0
FLTMD	FLTOUT	FLTTRIEN	OCINV	—	DCB1(3)	DCB0(3)	OC32
bit 15							bit 8

R/W-0	R/W-0, HS	R/W-0	R/W-0	R/W-1	R/W-1	R/W-0	R/W-0
OCTRIG	TRIGSTAT	OCTRIS	SYNCSEL4	SYNCSEL3	SYNCSEL2	SYNCSEL1	SYNCSEL0
bit 7							bit 0

Legend:	HS = Hardware Settable bit		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 15 **FLTMD:** Fault Mode Select bit
1 = Fault mode is maintained until the Fault source is removed and the corresponding OCFLT0 bit is cleared in software
0 = Fault mode is maintained until the Fault source is removed and a new PWM period starts

bit 14 **FLTOUT:** Fault Out bit
1 = PWM output is driven high on a Fault
0 = PWM output is driven low on a Fault

bit 13 **FLTTRIEN:** Fault Output State Select bit
1 = Pin is forced to an output on a Fault condition
0 = Pin I/O condition is unaffected by a Fault

bit 12 **OCINV:** Output Compare x Invert bit
1 = OCx output is inverted
0 = OCx output is not inverted

bit 11 **Unimplemented:** Read as '0'

bit 10-9 **DCB<1:0>:** PWM Duty Cycle Least Significant bits(3)
11 = Delays OCx falling edge by ¾ of the instruction cycle
10 = Delays OCx falling edge by ½ of the instruction cycle
01 = Delays OCx falling edge by ¼ of the instruction cycle
00 = OCx falling edge occurs at the start of the instruction cycle

bit 8 **OC32:** Cascade Two OC Modules Enable bit (32-bit operation)
1 = Cascade module operation is enabled
0 = Cascade module operation is disabled

bit 7 **OCTRIG:** Output Compare x Trigger/Sync Select bit
1 = Triggers OCx from the source designated by the SYNCSELx bits
0 = Synchronizes OCx with the source designated by the SYNCSELx bits

bit 6 **TRIGSTAT:** Timer Trigger Status bit
1 = Timer source has been triggered and is running
0 = Timer source has not been triggered and is being held clear

bit 5 **OCTRIS:** Output Compare x Output Pin Direction Select bit
1 = OCx pin is tri-stated
0 = Output Compare Peripheral x is connected to an OCx pin

Note 1: Never use an OCx module as its own trigger source, either by selecting this mode or another equivalent SYNCSELx setting.
2: Use these inputs as trigger sources only and never as sync sources.
3: The DCB<1:0> bits are double-buffered in PWM modes only (OCM<2:0> (OCxCON1<2:0>) = 111, 110).

16.3 Enhanced Slave Mode

To set up the SPIx module for the Enhanced Buffer Master mode of operation:

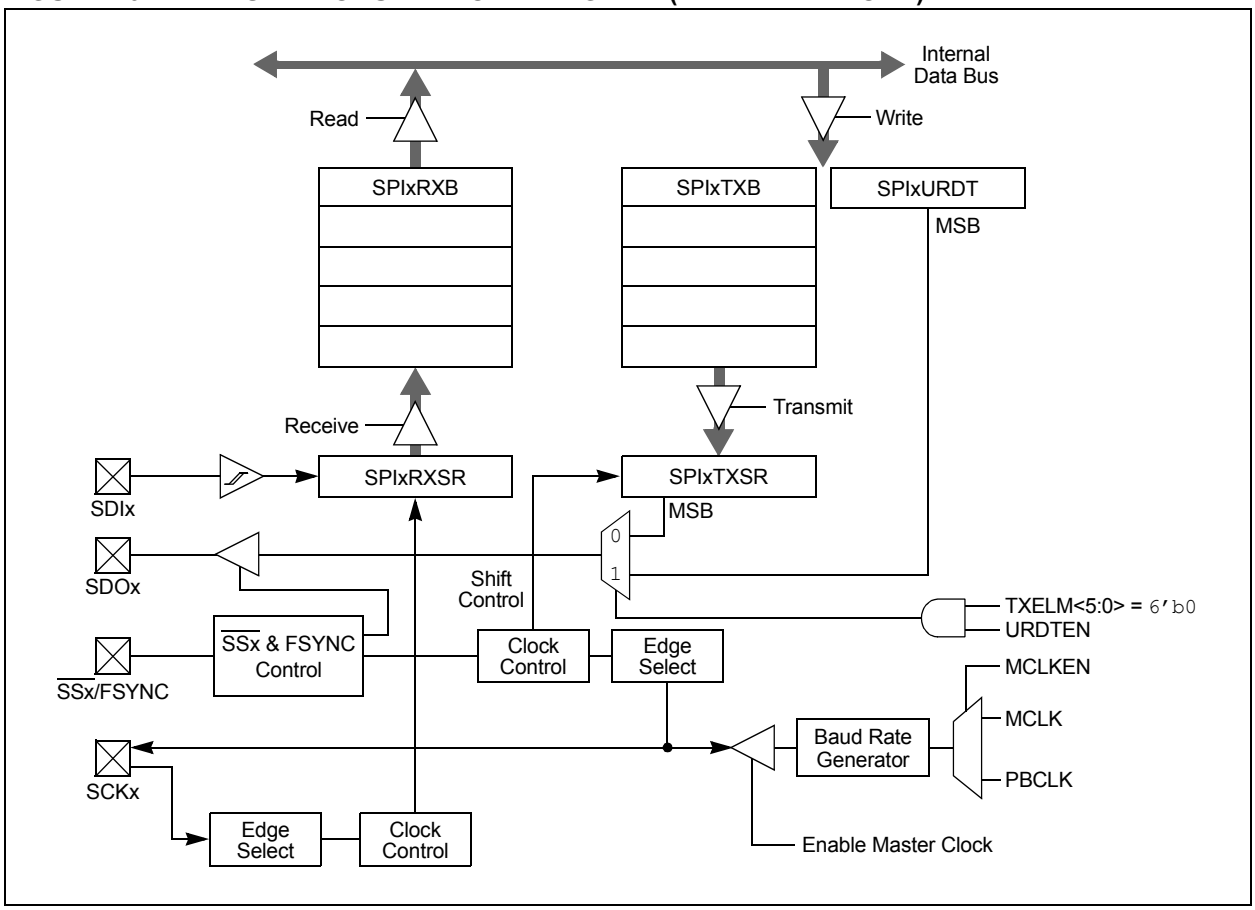
1. If using interrupts:
   a) Clear the interrupt flag bits in the respective IFSx register.
   b) Set the interrupt enable bits in the respective IECx register.
   c) Write the SPIxIP<2:0> bits in the respective IPCx register.
2. Write the desired settings to the SPIxCON1L, SPIxCON1H and SPIxCON2L registers with MSTEN (SPIxCON1L<5>) = 1.
3. Clear the SPIROV bit (SPIxSTATL<6>).
4. Select Enhanced Buffer mode by setting the ENHBUF bit (SPIxCON1L<0>).
5. Enable SPIx operation by setting the SPIEN bit (SPIxCON1L<15>).
6. Write the data to be transmitted to the SPIxBUFL and SPIxBUFH registers. Transmission (and reception) will start as soon as data is written to the SPIxBUFL and SPIxBUFH registers.

16.4 Enhanced Master Mode

To set up the SPIx module for the Enhanced Buffer Slave mode of operation:

1. Clear the SPIxBUFL and SPIxBUFH registers.
2. If using interrupts:
   a) Clear the interrupt flag bits in the respective IFSx register.
   b) Set the interrupt enable bits in the respective IECx register.
   c) Write the SPIxIP<2:0> bits in the respective IPCx register to set the interrupt priority.
3. Write the desired settings to the SPIxCON1L, SPIxCON1H and SPIxCON2L registers with the MSTEN bit (SPIxCON1L<5>) = 0.
4. Clear the SMP bit.
5. If the CKE bit is set, then the SSEN bit must be set, thus enabling the $\overline{SSx}$ pin.
6. Clear the SPIROV bit (SPIxSTATL<6>).
7. Select Enhanced Buffer mode by setting the ENHBUF bit (SPIxCON1L<0>).
8. Enable SPIx operation by setting the SPIEN bit (SPIxCON1L<15>).

FIGURE 16-2: SPIx MODULE BLOCK DIAGRAM (ENHANCED MODE)



REGISTER 18-5: UxSCCON: UARTx SMART CARD CONTROL REGISTER(1)

U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
—	—	—	—	—	—	—	—
bit 15							bit 8

U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
—	—	TXRPT1(2)	TXRPT0(2)	CONV	T0PD(2)	PTRCL	SCEN
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 15-6 **Unimplemented:** Read as '0'

bit 5-4 **TXRPT<1:0>:** Transmit Repeat Selection bits(2)
- 11 = Retransmits the error byte four times
- 10 = Retransmits the error byte three times
- 01 = Retransmits the error byte twice
- 00 = Retransmits the error byte once

bit 3 **CONV:** Logic Convention Selection bit
- 1 = Inverse logic convention
- 0 = Direct logic convention

bit 2 **T0PD:** Pull-Down Duration for T = 0 Error Handling bit(2)
- 1 = 2 ETU
- 0 = 1 ETU

bit 1 **PTRCL:** Smart Card Protocol Selection bit
- 1 = T = 1
- 0 = T = 0

bit 0 **SCEN:** Smart Card Mode Enable bit
- 1 = Smart Card mode is enabled if UARTEN (UxMODE<15>) = 1
- 0 = Smart Card mode is disabled

Note 1: This register is only available for UART1 and UART2.

2: These bits are applicable to T = 0 only, see PTRCL (UxSCCON<1>).

19.7.1 USB OTG MODULE CONTROL REGISTERS

REGISTER 19-3: U1OTGSTAT: USB OTG STATUS REGISTER (HOST MODE ONLY)

U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
—	—	—	—	—	—	—	—
bit 15							bit 8

R-0, HSC	U-0	R-0, HSC	U-0	R-0, HSC	R-0, HSC	U-0	R-0, HSC
ID	—	LSTATE	—	SESVD	SESEND	—	VBUSVD
bit 7							bit 0

Legend:	U = Unimplemented bit, read as '0'		
R = Readable bit	W = Writable bit	HSC = Hardware Settable/Clearable bit	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 15-8 **Unimplemented:** Read as '0'

bit 7 **ID:** ID Pin State Indicator bit
1 = No plug is attached or a Type B cable has been plugged into the USB receptacle
0 = A Type A plug has been plugged into the USB receptacle

bit 6 **Unimplemented:** Read as '0'

bit 5 **LSTATE:** Line State Stable Indicator bit
1 = The USB line state (as defined by SE0 and JSTATE) has been stable for the previous 1 ms
0 = The USB line state has not been stable for the previous 1 ms

bit 4 **Unimplemented:** Read as '0'

bit 3 **SESVD:** Session Valid Indicator bit
1 = The VBUS voltage is above VA_SESS_VLD (as defined in the *"USB 2.0 Specification"*) on the A or B-device
0 = The VBUS voltage is below VA_SESS_VLD on the A or B-device

bit 2 **SESEND:** B Session End Indicator bit
1 = The VBUS voltage is below VB_SESS_END (as defined in the *"USB 2.0 Specification"*) on the B-device
0 = The VBUS voltage is above VB_SESS_END on the B-device

bit 1 **Unimplemented:** Read as '0'

bit 0 **VBUSVD:** A VBUS Valid Indicator bit
1 = The VBUS voltage is above VA_VBUS_VLD (as defined in the *"USB 2.0 Specification"*) on the A-device
0 = The VBUS voltage is below VA_VBUS_VLD on the A-device

REGISTER 21-5: PMCSxCF: EPMP CHIP SELECT x CONFIGURATION REGISTER

R/W-0	R/W-0	R/W-0	R/W-0	U-0	R/W-0	R/W-0	R/W-0
CSDIS	CSP	CSPTEN	BEP	—	WRSP	RDSP	SM
bit 15							bit 8

R/W-0	R/W-0	R/W-0	U-0	U-0	U-0	U-0	U-0
ACKP	PTSZ1	PTSZ0	—	—	—	—	—
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 15 **CSDIS:** Chip Select x Disable bit
1 = Disables the Chip Select x functionality
0 = Enables the Chip Select x functionality

bit 14 **CSP:** Chip Select x Polarity bit
1 = Active-high (PMCSx)
0 = Active-low ($\overline{\text{PMCSx}}$)

bit 13 **CSPTEN:** PMCSx Port Enable bit
1 = PMCSx port is enabled
0 = PMCSx port is disabled

bit 12 **BEP:** Chip Select x Nibble/Byte Enable Polarity bit
1 = Nibble/byte enable is active-high (PMBE0, PMBE1)
0 = Nibble/byte enable is active-low ($\overline{\text{PMBE0}}$, $\overline{\text{PMBE1}}$)

bit 11 **Unimplemented:** Read as '0'

bit 10 **WRSP:** Chip Select x Write Strobe Polarity bit
For Slave Modes and Master Mode When SM = 0:
1 = Write strobe is active-high (PMWR)
0 = Write strobe is active-low ($\overline{\text{PMWR}}$)
For Master Mode When SM = 1:
1 = Enable strobe is active-high
0 = Enable strobe is active-low

bit 9 **RDSP:** Chip Select x Read Strobe Polarity bit
For Slave Modes and Master Mode When SM = 0:
1 = Read strobe is active-high (PMRD)
0 = Read strobe is active-low ($\overline{\text{PMRD}}$)
For Master Mode When SM = 1:
1 = Read/write strobe is active-high (PMRD/$\overline{\text{PMWR}}$)
0 = Read/write strobe is active-low ($\overline{\text{PMRD}}$/PMWR)

bit 8 **SM:** Chip Select x Strobe Mode bit
1 = Read/write and enable strobes (PMRD/$\overline{\text{PMWR}}$)
0 = Read and write strobes (PMRD and PMWR)

bit 7 **ACKP:** Chip Select x Acknowledge Polarity bit
1 = ACK is active-high (PMACK1)
0 = ACK is active-low ($\overline{\text{PMACK1}}$)

bit 6-5 **PTSZ<1:0>:** Chip Select x Port Size bits
11 = Reserved
10 = Reserved
01 = 4-bit port size (PMD<3:0>)
00 = 8-bit port size (PMD<7:0>)

bit 4-0 **Unimplemented:** Read as '0'

24.1.3 DATA SHIFT DIRECTION

The LENDIAN bit (CRCCON1<3>) is used to control the shift direction. By default, the CRC will shift data through the engine, MSb first. Setting LENDIAN (= 1) causes the CRC to shift data, LSb first. This setting allows better integration with various communication schemes and removes the overhead of reversing the bit order in software. Note that this only changes the direction the data is shifted into the engine. The result of the CRC calculation will still be a normal CRC result, not a reverse CRC result.

24.1.4 INTERRUPT OPERATION

The module generates an interrupt that is configurable by the user for either of two conditions.

If CRCISEL is '0', an interrupt is generated when the VWORD<4:0> bits make a transition from a value of '1' to '0'. If CRCISEL is '1', an interrupt will be generated after the CRC operation finishes and the module sets the CRCGO bit to '0'. Manually setting CRCGO to '0' will not generate an interrupt. Note that when an interrupt occurs, the CRC calculation would not yet be complete. The module will still need (PLEN + 1)/2 clock cycles, after the interrupt is generated, until the CRC calculation is finished.

24.1.5 TYPICAL OPERATION

To use the module for a typical CRC calculation:

1. Set the CRCEN bit to enable the module.
2. Configure the module for desired operation:
   a) Program the desired polynomial using the CRCXORL and CRCXORH registers, and the PLEN<4:0> bits.
   b) Configure the data width and shift direction using the DWIDTHx and LENDIAN bits.
   c) Select the desired Interrupt mode using the CRCISEL bit.
3. Preload the FIFO by writing to the CRCDATL and CRCDATH registers until the CRCFUL bit is set or no data is left.
4. Clear old results by writing 00h to CRCWDATL and CRCWDATH. The CRCWDAT registers can also be left unchanged to resume a previously halted calculation.
5. Set the CRCGO bit to start calculation.
6. Write remaining data into the FIFO as space becomes available.
7. When the calculation completes, CRCGO is automatically cleared. An interrupt will be generated if CRCISEL = 1.
8. Read CRCWDATL and CRCWDATH for the result of the calculation.

There are eight registers used to control programmable CRC operation:

- CRCCON1
- CRCCON2
- CRCXORL
- CRCXORH
- CRCDATL
- CRCDATH
- CRCWDATL
- CRCWDATH

The CRCCON1 and CRCCON2 registers (Register 24-1 and Register 24-2) control the operation of the module and configure the various settings.

The CRCXORL/H registers (Register 24-3 and Register 24-4) select the polynomial terms to be used in the CRC equation. The CRCDAT and CRCWDAT registers are each register pairs that serve as buffers for the double-word input data and CRC processed output, respectively.

REGISTER 24-1: CRCCON1: CRC CONTROL 1 REGISTER

R/W-0	U-0	R/W-0	R-0, HSC	R-0, HSC	R-0, HSC	R-0, HSC	R-0, HSC
CRCEN	—	CSIDL	VWORD4	VWORD3	VWORD2	VWORD1	VWORD0
bit 15							bit 8

R-0, HSC	R-1, HSC	R/W-0	R/W-0, HC	R/W-0	U-0	U-0	U-0
CRCFUL	CRCMPT	CRCISEL	CRCGO	LENDIAN	—	—	—
bit 7							bit 0

Legend:	HC = Hardware Clearable bit	HSC = Hardware Settable/Clearable bit	
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 15 **CRCEN:** CRC Enable bit
1 = Enables module
0 = Disables module; all state machines, pointers and the CRCWDAT/CRCDATH registers reset; other SFRs are NOT reset

bit 14 **Unimplemented:** Read as '0'

bit 13 **CSIDL:** CRC Stop in Idle Mode bit
1 = Discontinues module operation when device enters Idle mode
0 = Continues module operation in Idle mode

bit 12-8 **VWORD<4:0>:** Pointer Value bits
Indicates the number of valid words in the FIFO. Has a maximum value of 8 when PLEN<4:0> ≥ 7 or 16 when PLEN<4:0> ≤ 7.

bit 7 **CRCFUL:** CRC FIFO Full bit
1 = FIFO is full
0 = FIFO is not full

bit 6 **CRCMPT:** CRC FIFO Empty bit
1 = FIFO is empty
0 = FIFO is not empty

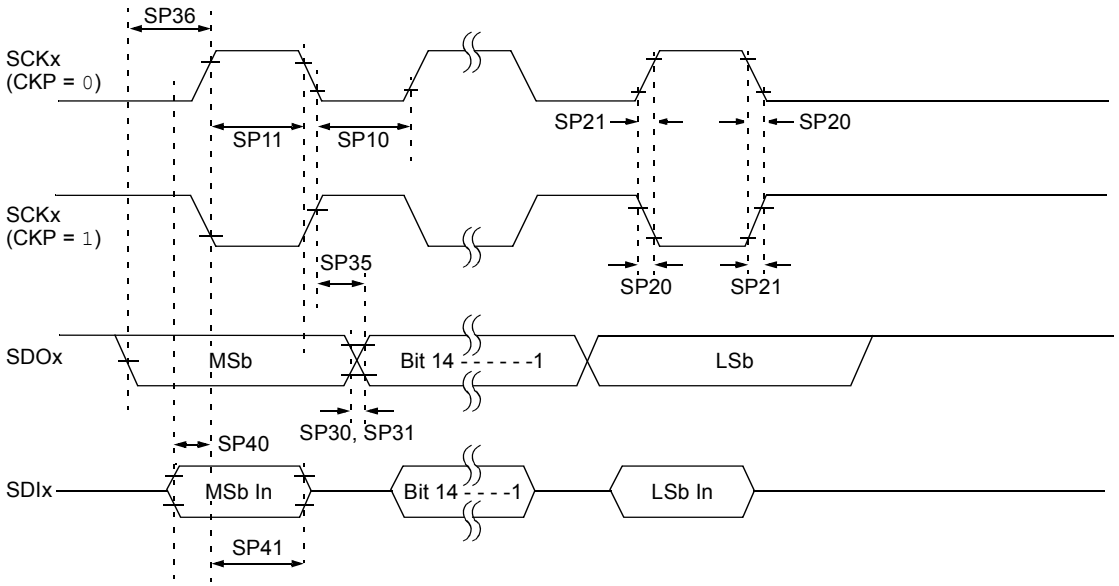
bit 5 **CRCISEL:** CRC Interrupt Selection bit
1 = Interrupt on FIFO is empty; the final word of data is still shifting through the CRC
0 = Interrupt on shift is complete and results are ready

bit 4 **CRCGO:** Start CRC bit
1 = Starts CRC serial shifter
0 = CRC serial shifter is turned off

bit 3 **LENDIAN:** Data Shift Direction Select bit
1 = Data word is shifted into the FIFO, starting with the LSb (little-endian)
0 = Data word is shifted into the FIFO, starting with the MSb (big-endian)

bit 2-0 **Unimplemented:** Read as '0'

FIGURE 33-10: SPIx MODULE MASTER MODE (CKE = 1) TIMING CHARACTERISTICS



Note: Refer to Figure 33-2 for load conditions.

TABLE 33-33: SPIx MODULE MASTER MODE (CKE = 1) TIMING REQUIREMENTS

AC CHARACTERISTICS			Standard Operating Conditions: 2.0V to 3.6V (unless otherwise stated) Operating temperature -40°C ≤ TA ≤ +85°C for Industrial -40°C ≤ TA ≤ +125°C for Extended				
Param No.	**Symbol**	**Characteristic(1)**	**Min**	**Typ(2)**	**Max**	**Units**	**Conditions**
SP10	TscL	SCKx Output Low Time(3)	TCY/2	—	—	ns	
SP11	TscH	SCKx Output High Time(3)	TCY/2	—	—	ns	
SP20	TscF	SCKx Output Fall Time(4)	—	—	—	ns	See Parameter DO32
SP21	TscR	SCKx Output Rise Time(4)	—	—	—	ns	See Parameter DO31
SP30	TdoF	SDOx Data Output Fall Time(4)	—	—	—	ns	See Parameter DO32
SP31	TdoR	SDOx Data Output Rise Time(4)	—	—	—	ns	See Parameter DO31
SP35	TscH2doV, TscL2doV	SDOx Data Output Valid After SCKx Edge	—	6	20	ns	
SP36	TdoV2sc, TdoV2scL	SDOx Data Output Setup to First SCKx Edge	30	—	—	ns	
SP40	TdiV2scH, TdiV2scL	Setup Time of SDIx Data Input to SCKx Edge	23	—	—	ns	
SP41	TscH2diL, TscL2diL	Hold Time of SDIx Data Input to SCKx Edge	30	—	—	ns	

Note 1: These parameters are characterized but not tested in manufacturing.

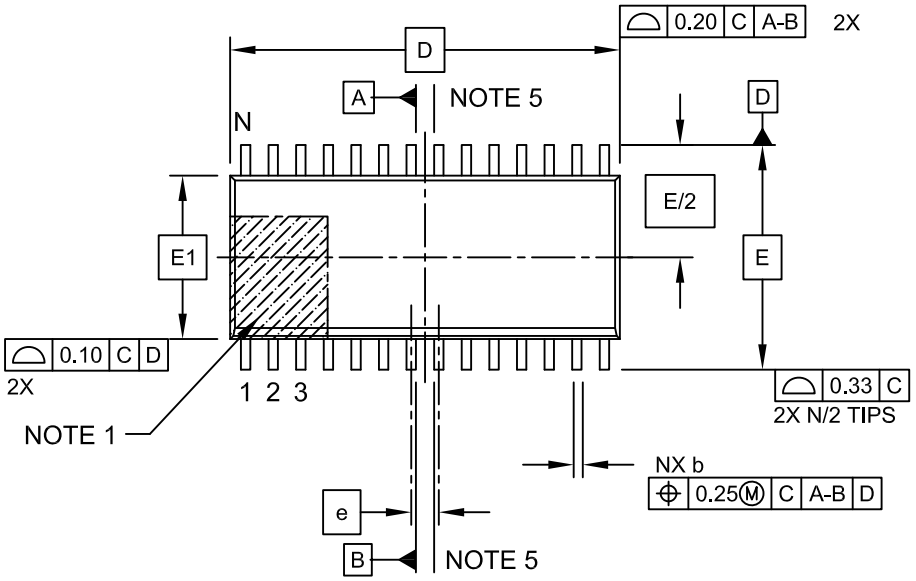
2: Data in "Typ" column is at 3.3V, +25°C unless otherwise stated.

3: The minimum clock period for SCKx is 100 ns. Therefore, the clock generated in Master mode must not violate this specification.

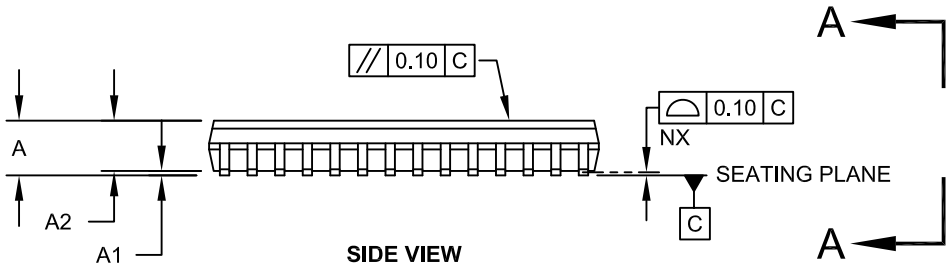
4: Assumes 50 pF load on all SPIx pins.

28-Lead Plastic Small Outline (SO) - Wide, 7.50 mm Body [SOIC]

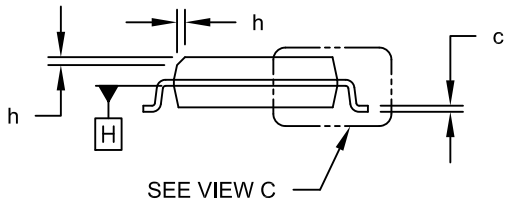
Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



TOP VIEW



SIDE VIEW

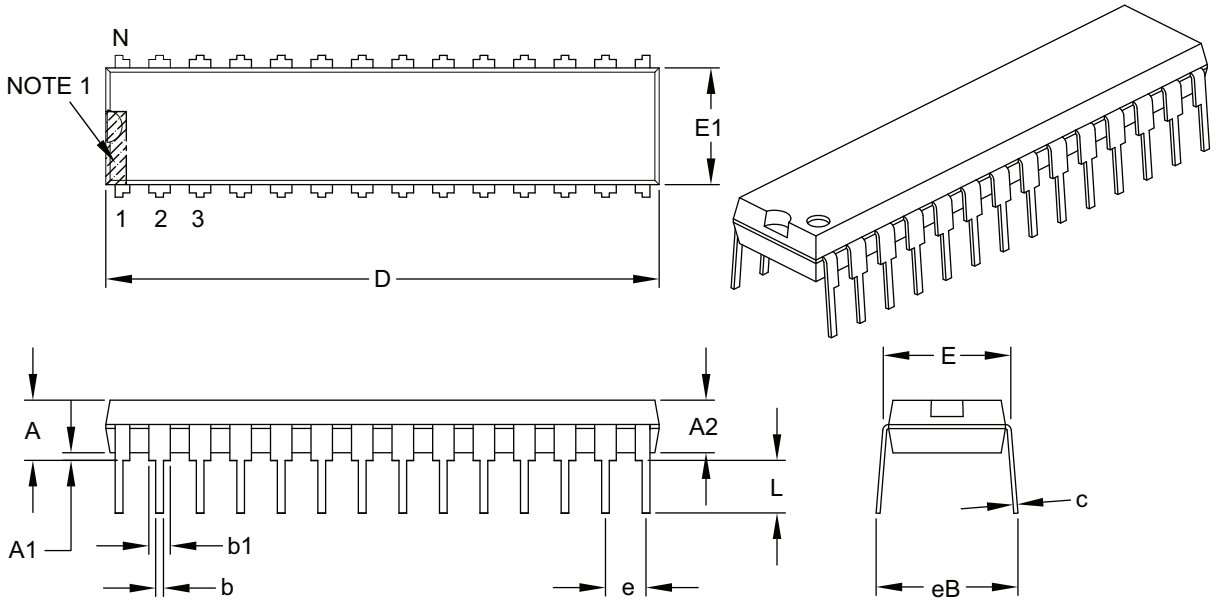


VIEW A-A

Microchip Technology Drawing C04-052C Sheet 1 of 2

28-Lead Skinny Plastic Dual In-Line (SP) – 300 mil Body [SPDIP]

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



Units		INCHES		
Dimension Limits		MIN	NOM	MAX
Number of Pins	N		28	
Pitch	e		.100 BSC	
Top to Seating Plane	A	–	–	.200
Molded Package Thickness	A2	.120	.135	.150
Base to Seating Plane	A1	.015	–	–
Shoulder to Shoulder Width	E	.290	.310	.335
Molded Package Width	E1	.240	.285	.295
Overall Length	D	1.345	1.365	1.400
Tip to Seating Plane	L	.110	.130	.150
Lead Thickness	c	.008	.010	.015
Upper Lead Width	b1	.040	.050	.070
Lower Lead Width	b	.014	.018	.022
Overall Row Spacing §	eB	–	–	.430

Notes:

1. Pin 1 visual index feature may vary, but must be located within the hatched area.
2. § Significant Characteristic.
3. Dimensions D and E1 do not include mold flash or protrusions. Mold flash or protrusions shall not exceed .010" per side.
4. Dimensioning and tolerancing per ASME Y14.5M.

   BSC: Basic Dimension. Theoretically exact value shown without tolerances.

Microchip Technology Drawing C04-070B